

# HSM88AS

## Silicon Schottky Barrier Diode for Balanced Mixer

# HITACHI

Rev. 4  
Jul. 1994

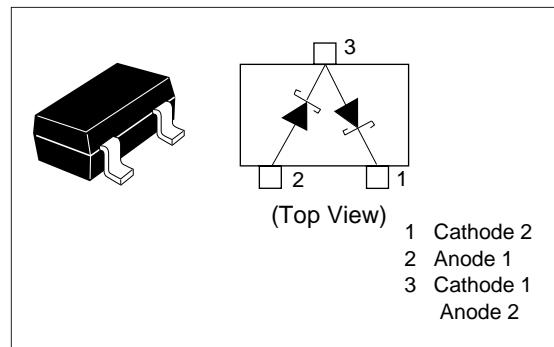
### Features

- Proof against high voltage.
- MPAK package is suitable for high density surface mounting and high speed assembly.

### Ordering Information

Type No.	Laser Mark	Package Code
HSM88AS	C 1	MPAK

### Pin Arrangement



### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Item	Symbol	Value	Unit
Reverse voltage	$V_R$	10	V
Average rectified	$I_o$ *	15	mA
Junction temperature	$T_j$	100	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +100	$^\circ\text{C}$
Operation temperature	$T_{opr}$	-40 to +85	$^\circ\text{C}$

\* Per one device

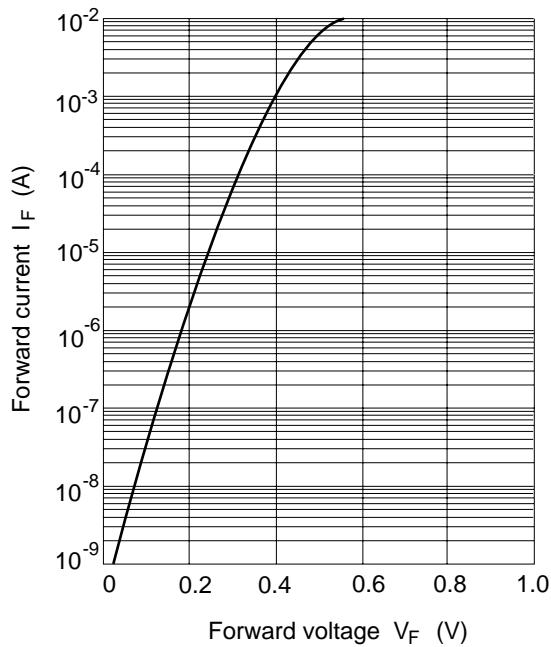
### Electrical Characteristics ( $T_a = 25^\circ\text{C}$ ) \*

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	$V_{F1}$	350	—	420	mV	$I_F = 1 \text{ mA}$
	$V_{F2}$	500	—	580		$I_F = 10 \text{ mA}$
Reverse current	$I_{R1}$	—	—	0.2	$\mu\text{A}$	$V_R = 2 \text{ V}$
	$I_{R2}$	—	—	10		$V_R = 10 \text{ V}$
Capacitance	C	—	—	0.85	pF	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$
Capacitance deviation	$\Delta C$	—	—	0.10	pF	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$
Forward voltage deviation	$\Delta V_F$	—	—	10	mV	$I_F = 10 \text{ mA}$
ESD Capability	—	30	—	—	V	** C=200pF, Both forward and reverse direction 1 pulse

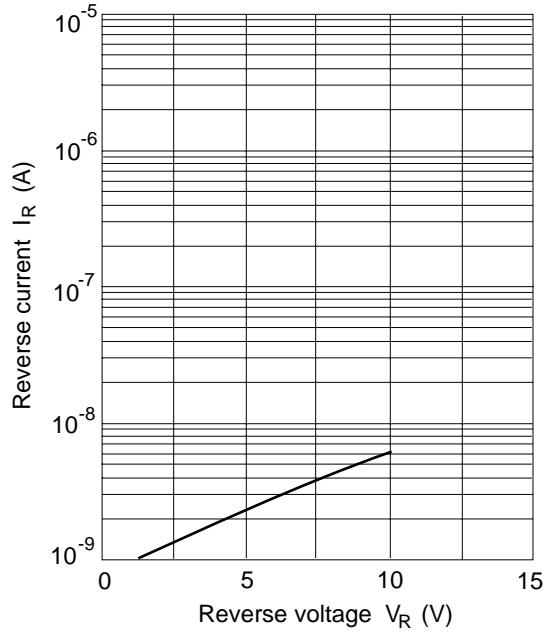
\* Per one device

\*\* Failure Criterion :  $I_R \geq 400\text{nA}$  at  $V_R = 2\text{V}$

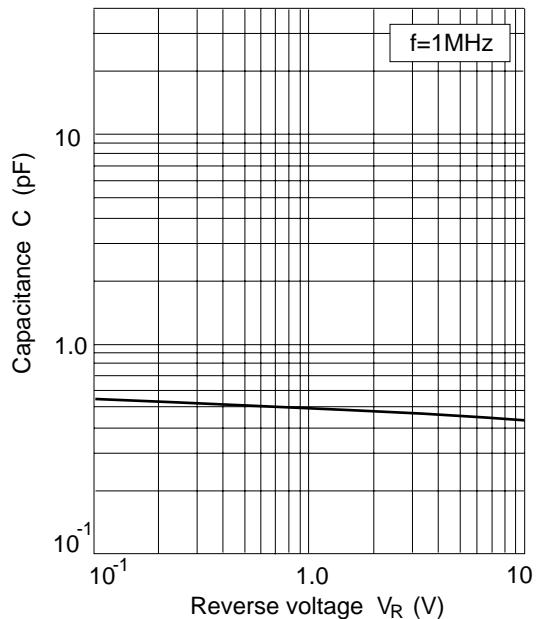
## HSM88AS



**Fig.1** Forward current Vs.  
Forward voltage



**Fig.2** Reverse current Vs.  
Reverse voltage



**Fig.3** Capacitance Vs.  
Reverse voltage

**Package Dimensions**

Unit: mm

